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FDB0190N807L N-Channel PowerTrench[®] MOSFET 80 V, 270 A, 1.7 m Ω

Features

- Max r_{DS(on)} = 1.7 mΩ at V_{GS} = 10 V, I_D = 34 A
- Max $r_{DS(on)}$ = 2 m Ω at V_{GS} = 8 V, I_D = 31 A
- Fast Switching Speed
- Low Gate Charge
- \blacksquare High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- High Power and Current Handling Capability
- RoHS Compliant

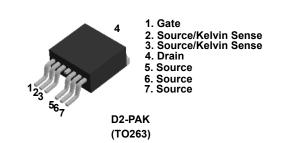


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been especially tailored to minimize the on-state resistance while maintaining superior ruggedness and switching performance for industrial applications.

Applications

- Industrial Motor Drive
- Industrial Power Supply
- Industrial Automation
- Battery Operated tools
- Battery Protection
- Solar Inverters
- UPS and Energy Inverters
- Energy Storage
- Load Switch



D(Pin4, tab) G (Pin1) S(Pin2,3,5,6,7)

MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			80	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous	T _C = 25°C	(Note 5)	270		
	-Continuous	T _C = 100°C	(Note 5)	190	Α	
	-Pulsed		(Note 4)	1440		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	777	mJ	
P _D	Power Dissipation	T _C = 25°C		250	w	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.8		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	0.6	°C 1.1/
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB0190N807L	FDB0190N807L	D2-PAK-7L	330 mm	24 mm	800 units

March 2016

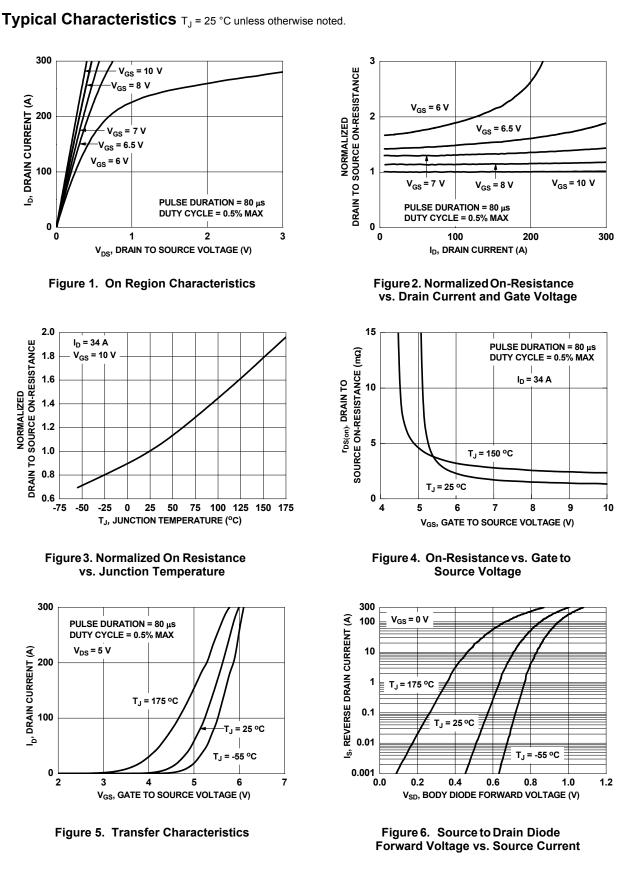
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	80			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		34		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 64 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2	2.9	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-13		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 34 A		1.3	1.7	
		V _{GS} = 8 V, I _D = 31 A		1.5	2	mΩ
		V_{GS} = 10 V, I _D = 34 A, T _J = 150°C		2.3	4.3	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 34 A		133		S
C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance			13650 1990 235	19110 2790 330	pF pF pF
R _g	Gate Resistance			2.9		Ω
	g Characteristics					
	Turn-On Delay Time			60	96	ns
ld(on)	Rise Time	V _{DD} = 40 V, I _D = 34 A,		78	125	ns
	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		98	157	ns
t _r		-		50	80	ns
t _r t _{d(off)} t _f	Fall Time			178	249	nC
t _r t _{d(off)} t _f	Fall Time Total Gate Charge	1/1 = 401/1 = 24.4		60		nC
t _r t _{d(off)} t _f Q _g		$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 34 \text{ A},$ $V_{DD} = 10 \text{ V}$		00		nC
t _{d(off)}	Total Gate Charge	V _{DD} = 40 V, I _D = 34 A, V _{GS} = 10 V		32		
t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate to Source Gate Charge					110
t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge	$-V_{GS} = 10 V$			270	A
t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-So I _S	Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 10 V$			270 1440	
t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-So I _S I _S	Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Maximum Continuous Drain to Source Diode	$V_{GS} = 10 V$				A
t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-So I _S	Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge urce Diode Characteristics Maximum Continuous Drain to Source Diode Feature Maximum Pulsed Drain to Source Diode Feature	de Forward Current		32	1440	A

2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0 %.

3. E_{AS} of 777 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 72 A, V_{DD} = 72 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 104 A.

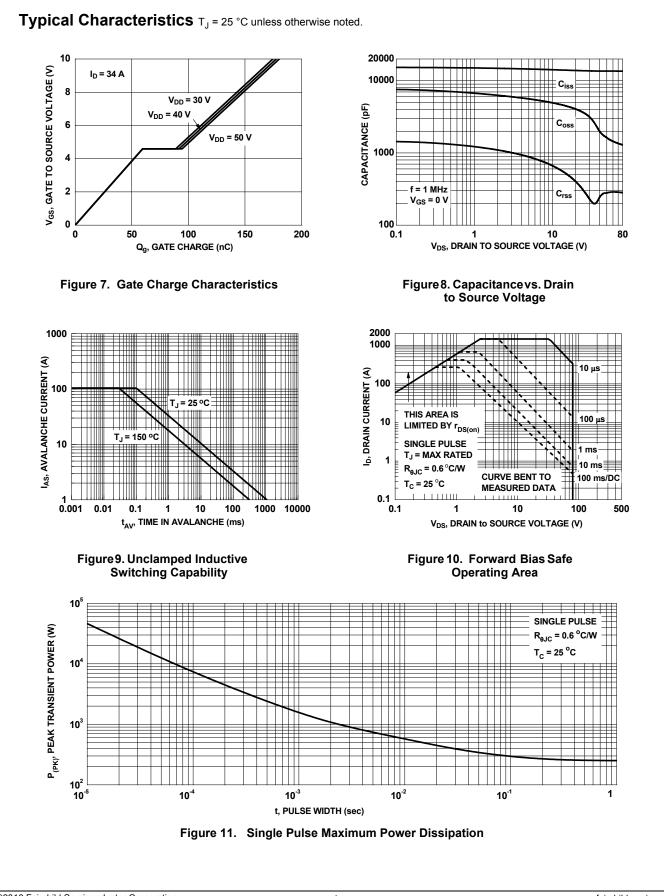
4. Pulsed Id please refer to Figure "Forward Bias Safe Operating Area" for more details.

5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

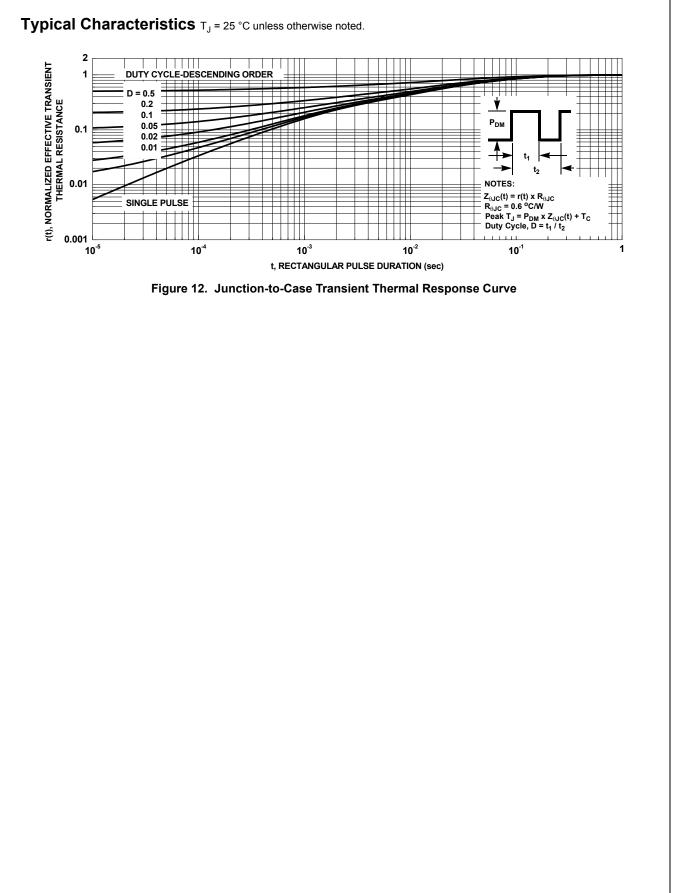


FDB0190N807L N-Channel PowerTrench[®] MOSFET

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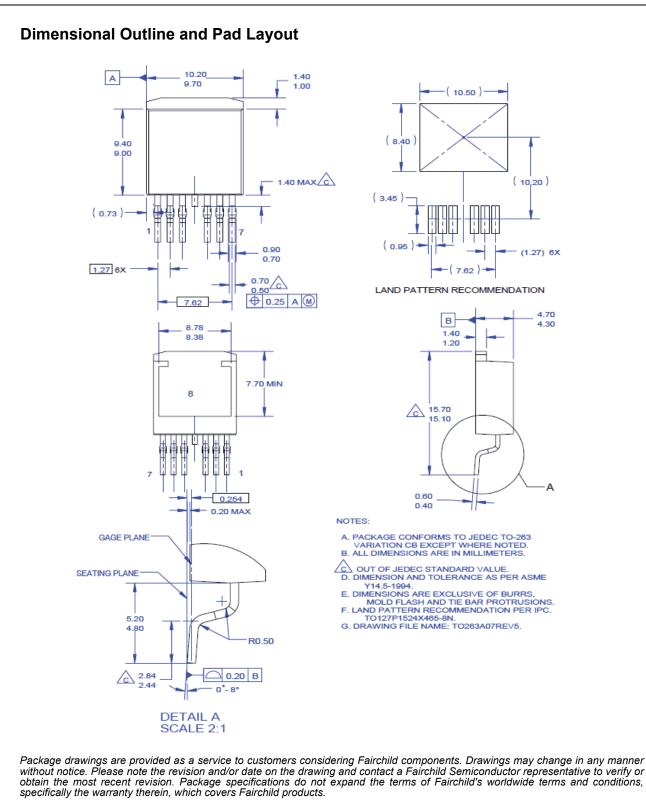


FDB0190N807L N-Channel PowerTrench[®] MOSFET



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FDB0190N807L Rev.C



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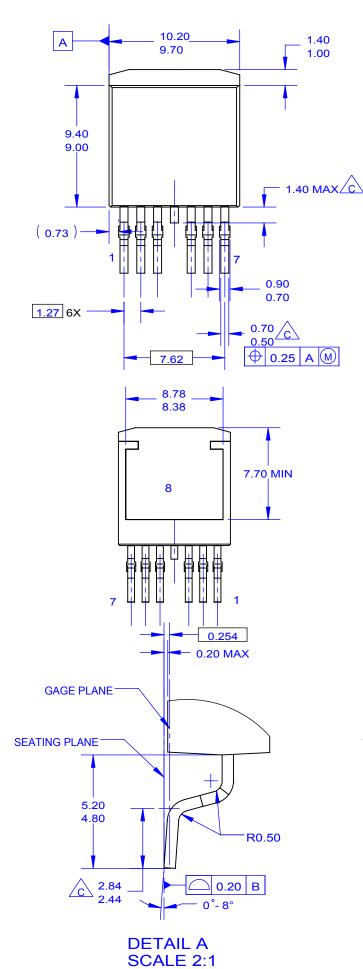
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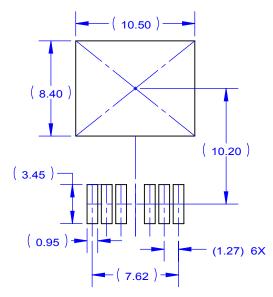
PRODUCT STATUS DEFINITIONS

Definition of Terms

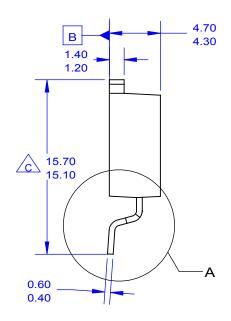
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 177





LAND PATTERN RECOMMENDATION



NOTES:

- A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED.
 B. ALL DIMENSIONS ARE IN MILLIMETERS.
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